

[Home](#) | [Login](#) | [Logout](#) | [Access Information](#) | [Alerts](#) |

Welcome United States Patent and Trademark Office

**Search Results**[BROWSE](#)[SEARCH](#)[IEEE Xplore GUIDE](#)[e-mail](#)

Results for "(elfadel i. m.&lt;in&gt;au)"

Your search matched 26 of 1387402 documents.

A maximum of 100 results are displayed, 25 to a page, sorted by **Relevance in Descending order**.**» Search Options**[View Session History](#)[New Search](#)**Modify Search** Check to search only within this results setDisplay Format:  Citation  Citation & Abstract**» Key****IEEE JNL** IEEE Journal or Magazine [Select All](#) [Deselect All](#)**IEE JNL** IEE Journal or Magazine 1. **Efficient frequency-domain modeling and circuit simulation of transmissi**Silveira, L.M.; Elfadel, I.M.; White, J.K.; Chilukuri, M.; Kundert, K.S.;  
*Components, Packaging, and Manufacturing Technology, Part B: Advanced Pa*  
*Transactions on* [see also *Components, Hybrids, and Manufacturing Technolo*  
*Transactions on*]Volume 17, Issue 4, Nov. 1994 Page(s):505 - 513  
Digital Object Identifier 10.1109/96.338715[AbstractPlus](#) | [Full Text: PDF\(792 KB\)](#) [IEEE JNL](#)  
[Rights and Permissions](#) 2. **Gibbs random fields, cooccurrences, and texture modeling**Elfadel, I.M.; Picard, R.W.;  
*Pattern Analysis and Machine Intelligence, IEEE Transactions on*  
Volume 16, Issue 1, Jan. 1994 Page(s):24 - 37  
Digital Object Identifier 10.1109/34.273719[AbstractPlus](#) | [Full Text: PDF\(1312 KB\)](#) [IEEE JNL](#)  
[Rights and Permissions](#) 3. **A comparative study of two transient analysis algorithms for lossy trans**  
**with frequency-dependent data**Elfadel, I.M.; Hao-Ming Huang; Ruehli, A.E.; Dounavis, A.; Nakhla, M.S.;  
*Advanced Packaging, IEEE Transactions on* [see also *Components, Packaging,*  
*Manufacturing Technology, Part B: Advanced Packaging, IEEE Transactions o*  
Volume 25, Issue 2, May 2002 Page(s):143 - 153  
Digital Object Identifier 10.1109/TADVP.2002.803270[AbstractPlus](#) | [References](#) | [Full Text: PDF\(616 KB\)](#) [IEEE JNL](#)  
[Rights and Permissions](#) 4. **A multiconductor transmission line methodology for global on-chip inter**  
**modeling and analysis**Elfadel, I.M.; Deutsch, A.; Smith, H.H.; Rubin, B.J.; Kopcsay, G.V.;  
*Advanced Packaging, IEEE Transactions on* [see also *Components, Packaging,*  
*Manufacturing Technology, Part B: Advanced Packaging, IEEE Transactions o*  
Volume 27, Issue 1, Feb. 2004 Page(s):71 - 78  
Digital Object Identifier 10.1109/TADVP.2004.825478[AbstractPlus](#) | [References](#) | [Full Text: PDF\(264 KB\)](#) [IEEE JNL](#)  
[Rights and Permissions](#)


[Subscribe \(Full Service\)](#) [Register \(Limited Service, Free\)](#) [Login](#)
 The ACM Digital Library  The Guide


**THE ACM DIGITAL LIBRARY**
[Feedback](#) [Report a problem](#) [Satisfaction survey](#)
Term used Elfadel

Found 8 of 183,790

 Sort results by 
 [Save results to a Binder](#)
[Try an Advanced Search](#)

 Display results 
 [Search Tips](#)
[Try this search in The ACM Guide](#)
 [Open results in a new window](#)

Results 1 - 8 of 8

Relevance scale

1 [Zeros and passivity of Arnoldi-reduced-order models for interconnect networks](#)

I. M. Elfadel, David D. Ling

June 1997 **Proceedings of the 34th annual conference on Design automation DAC '97**

**Publisher:** ACM Press

Full text available: [pdf\(104.86 KB\)](#) Additional Information: [full citation](#), [abstract](#), [references](#), [citations](#), [index terms](#)  
[Publisher Site](#)

CAD tools and research in the area of reduced-order modeling of large linear interconnect networks have evolved from merely finding a Padé approximation for the given network transfer function to finding an approximate transfer function that preserves such circuit-theoretic properties of the network as stability, passivity, and RLC synthesizability. In particular, preserving passivity guarantees that the reduced-order models will be well-behaved when embedded back in the circuit where the interconnect ...

2 [Gradient-based optimization of custom circuits using a static-timing formulation](#)

A. R. Conn, I. M. Elfadel, W. W. Molzen, P. R. O'Brien, P. N. Strenski, C. Visweswariah, C. B. Whan

June 1999 **Proceedings of the 36th ACM/IEEE conference on Design automation**

**Publisher:** ACM Press

Full text available: [pdf\(105.82 KB\)](#) Additional Information: [full citation](#), [references](#), [citations](#), [index terms](#)

3 [A block rational Arnoldi algorithm for multipoint passive model-order reduction of multiport RLC networks](#)

I. M. Elfadel, David D. Ling

November 1997 **Proceedings of the 1997 IEEE/ACM international conference on Computer-aided design**

**Publisher:** IEEE Computer Society

Full text available: [pdf\(225.42 KB\)](#) Additional Information: [full citation](#), [abstract](#), [references](#), [citations](#), [index terms](#)  
[Publisher Site](#)

Recent work in the area of model-order reduction for RLC interconnect networks has been focused on building reduced-order models that preserve the circuit-theoretic properties of the network, such as stability, passivity, and synthesizability. Passivity is the one circuit-theoretic property that is vital for the successful simulation of a large circuit netlist containing reduced-order models of its interconnect networks. Non-passive reduced-order

[Sign in](#)[Web](#) [Images](#) [Groups](#) [News](#) [Froogle](#) [Maps](#) [more »](#)

transmission line macromodel

[Advanced Search](#)  
[Preferences](#)**Web**Results 11 - 20 of about 50,400 for **transmission line macromodel**. (0.12 seconds)[\[PDF\] A comparative study of two transient analysis algorithms for lossy ...](#)

File Format: PDF/Adobe Acrobat

The **transmission line macromodel** is a dynamically loadable library (DLL) that communicates with the circuit solver (in our case IBM's PowerSpice) using ...[ieeexplore.ieee.org/iel5/6040/22489/01049624.pdf?arnumber=1049624](#) - [Similar pages](#)[\[PDF\] Transient Analysis of Lossy Transmission Lines: An Efficient ...](#)

File Format: PDF/Adobe Acrobat

sequent generation of a **line macromodel** to be employed in a ... the delay could model the lossy **transmission line** behavior [11], [18], [19]. ...[ieeexplore.ieee.org/iel5/6040/28720/01288269.pdf?isnumber=28720&arnumber=1288269](#) - [Similar pages](#)[\[PS\] Transient Analysis of Coupled Transmission Lines Characterized ...](#)File Format: Adobe PostScript - [View as Text](#)this approach, the **macromodel** of **transmission lines** characterized with the ...**transmission lines** [25]. The **macromodel** of the single **transmission line** that ...[www.cse.ucsc.edu/research/reports/ucsc-crl-95-04.ps.Z](#) - [Similar pages](#)[ [More results from www.cse.ucsc.edu](#) ][\[PDF\] On-the-Fly Estimation of IC Macromodels for the Assessment of High ...](#)File Format: PDF/Adobe Acrobat - [View as HTML](#)driver connected to an ideal **transmission line** load (characteristic impedance  $Z_0$  ... **line**:reference, dashed **line**: **macromodel** estimated from noisy signals. ...[domino.research.ibm.com/acas/w3www\\_acas.nsf/images/conf06/\\$FILE/canavero.pdf](#) -[Similar pages](#)**DOE**P. Gunupudi, R. Khazaka, and M. Nakhla, "Analysis of **transmission line** circuits using ..."Time domain reduced order **macromodel** for interconnects excited by ...[www.doe.carleton.ca/~pavan/php/publications.php](#) - 16k - [Cached](#) - [Similar pages](#)[A new time-domain \*\*macromodel\*\* for transient simulation of uniform ...](#)A new time-domain **macromodel** for transient simulation of uniform/nonuniformmulticonductor **transmission-line** interconnections ...[portal.acm.org/citation.cfm?id=196596&coll=portal&dl=ACM](#) - [Similar pages](#)

## TRANSIENT ANALYSIS OF COUPLED TRANSMISSION LINES USING SCATTERING ...

**TRANSIENT ANALYSIS OF COUPLED TRANSMISSION LINES USING SCATTERING**PARAMETER BASED **MACROMODEL**. Source. Technical Report: UCSC-CRL-94-09 ...[portal.acm.org/citation.cfm?coll=GUIDE&dl=GUIDE&id=902665](#) - [Similar pages](#)[\[PDF\] ISSCC2001 SESSION 25 / PAPER WO 25.5](#)File Format: PDF/Adobe Acrobat - [View as HTML](#)shows the **macromodel** of a **transmission line** segment. (b) shows capacitances of the transistors broken out. Figure 4) Die photograph of prototype chip. ...[www.mutligig.com/publications/ISSCC2001\\_25.5\\_preprint.pdf](#) - [Similar pages](#)